

Smart Multi-Voltage Detector

General Description

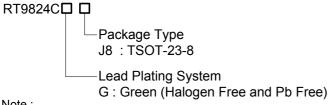
The RT9824C is an integrated smart multi-voltage detector supervising three power supply voltage levels including 5V, 5.4V and additional 3.3V, 12V or other voltage which can be determined by external divided resisters.

The RT9824C performs supervisory function by sending out RESET and CTR signals whenever the monitored voltages fall below 80% of voltage levels. The RESET and CTR signals will last the whole period before VCC recovering. Once the supervising voltages are recovered to higher than 80% of the voltage levels, the RESET and CTR signal will be released after 60ms delay time.

MR (Manual Reset) controls CTR signal during three monitored power supply voltages at normal voltage levels. When MR signal is in logic high, the CTR signal will be pulled low immediately. However the RESET will not be interfered and will be kept at high level.

The RT9824C is available in the TSOT-23-8 package.

Ordering Information

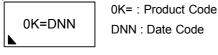


Note:

Richtek products are:

- > RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

Marking Information



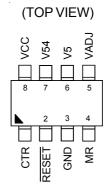
Features

- Capable of Monitoring Three Inputs Precisely
- Detection Threshold Voltages
 - ▶ VCC Connect to 5V or 3.3V Standby Power
 - ▶ V5 : 5V x 80% ▶ V54 : 5.4V x 80%
 - ▶ VADJ: 1V (Using Resistor Divider)
- Accuracy: ±2%
- RESET (Open Drain Output Active Low)
- Built-in Recovery Delay 60ms
- CTR (Open Drain Output Active Low)
- Manual Reset (MR) Function
- TSOT-23-8 Package
- RoHS Compliant and Halogen Free

Applications

- LCD TV or Monitors
- Consumer Electronic Products
- System Voltage Detector

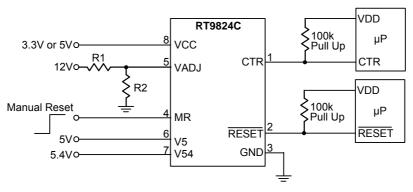
Pin Configurations



TSOT-23-8



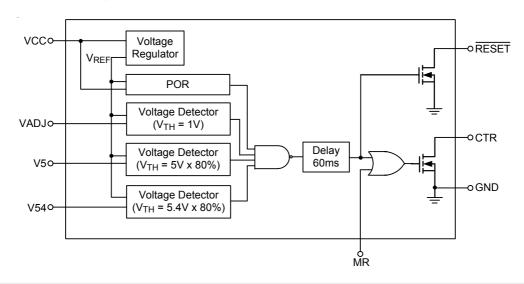
Typical Application Circuit



Functional Pin Description

Pin No.	Pin Name	Pin Function
1	CTR	Control Output (Open Drain, Active-Low). Only when V_{CC} is > POR, V5 is > 80%, V54 is > 80%, and V_{ADJ} is > 1V, the CTR will delay 60ms and become high. Once V5 or V54 or V_{ADJ} is <80%, the signal will become low. When MR is high, CTR will become low.
2	RESET	RESET Output (Open Drain, Active-Low). Only when V_{CC} is > POR, V5 is > 80%, V54 is > 80%, and V_{ADJ} is > 1V, the RESET will delay 60ms and become high. Once V5 or V54 or V_{ADJ} is < 80%, the signal will become low.
3	GND	Ground.
4	MR	Manual Reset Input. Manual reset with internal pull high resister (1M Ω), H : CTR = Low; L : CTR signal is dependent on voltage detector output.
5	VADJ	Voltage Detection Input. Connect 12V or other power with external resister divider to this pin. The V_{ADJ} logic-high threshold voltage is 1V.
6	V5	5V Voltage Detection Input. The detection threshold is 5V x 80%.
7	V54	54V Voltage Detection Input. The detection threshold is 5.4V x 80%.
8	VCC	Connect this Pin to Standby Power from system.

Function Block Diagram



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Operation

The RT9824 smart voltage detector monitors three voltage levels at the same time to ensure the micro-processor is operated within the recommended input voltage range. In conventional reset IC application, to monitor one power rail needs one reset IC. The RT9824 can monitor three power rails simultaneously, by using just one reset IC. The RT9824 also provides a Manual Reset (MR) function for application easily. Glitch-rejection is implemented in the RT9824 to prevent it from false operation and to eliminate the additional de-bouncing circuitry.

POR Protection

To protect the chip from operating at insufficient supply voltage, the POR is needed. When the input voltage of VIN is lower than the POR falling threshold voltage, the device will be lockout.



Absolute Maximum Ratings (Note 1)

• VCC, CTR, MR, RESET, V5, V54, VADJ	0.3V to 6.5V
 Power Dissipation, P_D @ T_A = 25°C 	
TSOT-23-8	0.435W
Package Thermal Resistance (Note 2)	
TSOT-23-8, θ_{JA}	230°C/W
• Junction Temperature	150°C
• Lead Temperature (Soldering, 10 sec.)	260°C
Storage Temperature Range	65°C to 150°C
ESD Susceptibility (Note 3)	
HBM (Human Body Model)	2kV
MM (Machine Model)	200V

Recommended Operating Conditions (Note 4)

• Junction Temperature Range ------ -40°C to 125°C

Electrical Characteristics

(V_{CC} = 5V, T_A = 25°C, unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit				
VCC Supply Current	lvcc	Without load			200	μΑ				
VCC Operating Voltage	Vcc		2.97	5	5.94	V				
VCC POR Rising	VPOR			2.8	-	V				
VCC POR Hysteresis	VPOR_Hys			0.15		V				
Voltage Detector & MUTE Threshold										
V5 High Threshold Voltage	V5тн		3.92	4	4.08	V				
V54 High Threshold Voltage	V54 _{TH}		4.23	4.32	4.41	V				
VADJ High Threshold Voltage	VADJ _{TH}		0.98	1	1.02	V				
Manual Reset High Voltage	ViH		2			V				
Manual Reset Low Voltage	V _{IL}				0.8	V				
Voltage Detector Deglitch and Delay										
Voltage Detectors Delay Time	T _{DELAY}		45	60	80	ms				
Voltage Detectors Deglitch Time	T _{DEGLITCH}			20		μS				
Output : Open Drain										
RESET Output Low Voltage	V _{OL_RESET}	V_{CC} = 3.3V, 5mA sinking current at RESET output			0.3	٧				
CTR Output Low Voltage	V _{OL_CTR}	V _{CC} = 3.3V, 5mA sinking current at CTR output			0.3	V				

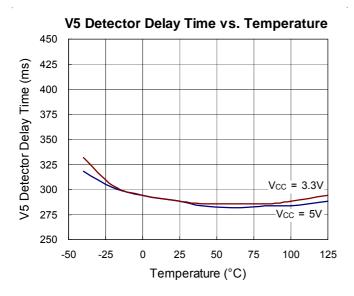
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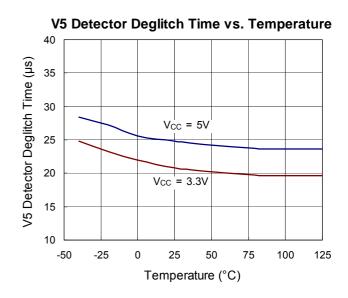


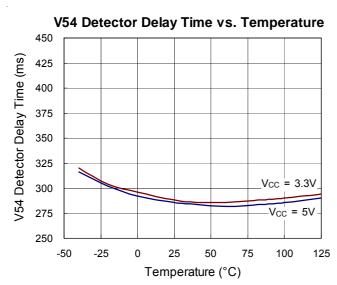
- **Note 1.** Stresses beyond those listed "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
- Note 2. θ_{JA} is measured at $T_A = 25^{\circ}$ C on a low effective thermal conductivity single-layer test board per JEDEC 51-3.
- Note 3. Devices are ESD sensitive. Handling precaution is recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.

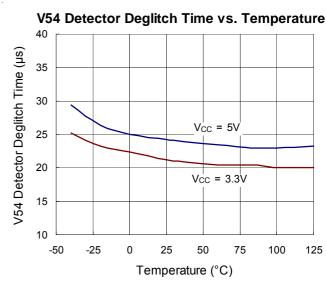


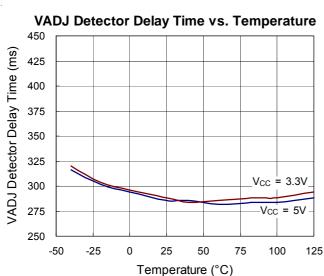
Typical Operating Characteristics

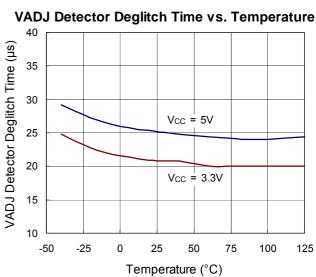






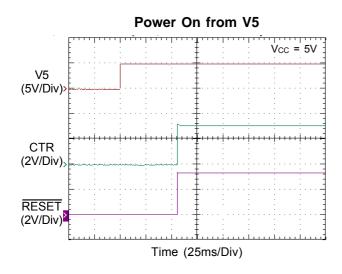


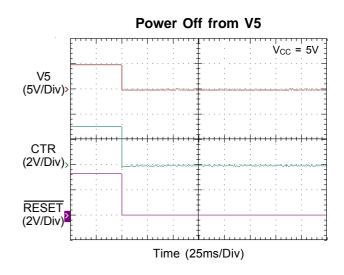


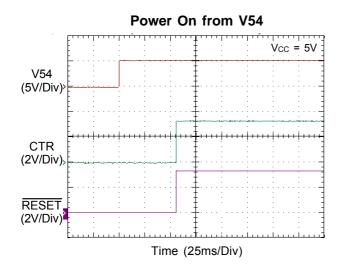


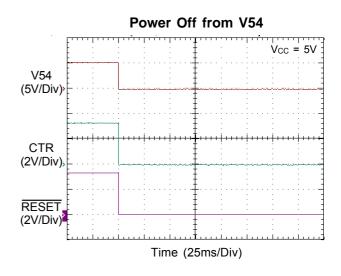
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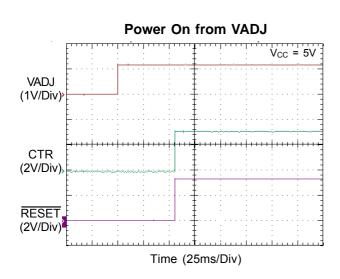


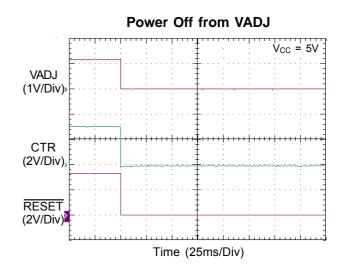








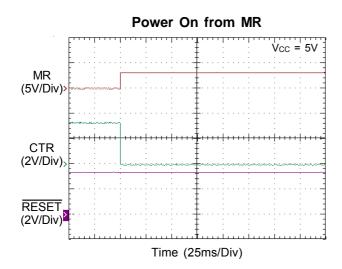


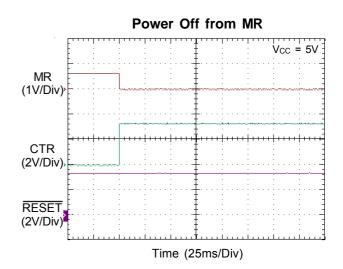


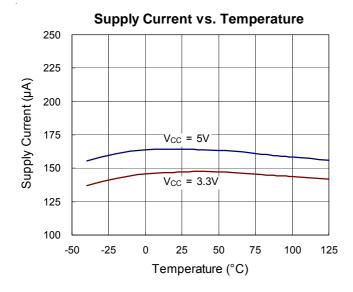
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DS9824C-00 August 2014 www.richtek.com











Application Information

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Thermal Considerations

For continuous operation, do not exceed absolute maximum operation junction temperature. The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surroundings airflow and temperature difference between junction to ambient. The maximum power dissipation can be calculated by following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

Where $T_{J(MAX)}$ is the maximum operation junction temperature, T_A is the ambient temperature and the θ_{JA} is the junction to ambient thermal resistance.

For recommended operating conditions specification, the maximum junction temperature is 125°C. The junction to ambient thermal resistance θ_{JA} is layout dependent. For TSOT-23-8 package, the thermal resistance θ_{JA} is 250°C/W on the standard JEDEC 51-3 single layer thermal test board. The maximum power dissipation at T_A = 25°C can be calculated by following formula :

 $P_{D(MAX)}$ = (125°C - 25°C) / (230°C/W) = 0.435W for TSOT-23-8 package

The maximum power dissipation depends on operating ambient temperature for fixed $T_{J(MAX)}$ and thermal resistance θ_{JA} . The Figure 1 of derating curve allows the designer to see the effect of rising ambient temperature on the maximum power dissipation allowed.

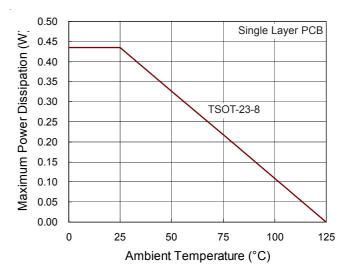
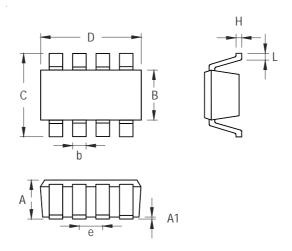


Figure 1. Derating Curve of Maximum Power Dissipation



Outline Dimension



Sumbal	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
А	0.700	1.000	0.028	0.039	
A1	0.000	0.100	0.000	0.004	
В	1.397	1.803	0.055	0.071	
b	0.220	0.380	0.009	0.015	
С	2.591	3.000	0.102	0.118	
D	2.692	3.099	0.106	0.122	
е	0.585	0.715	0.023	0.028	
Н	0.080	0.254	0.003	0.010	
L	0.300	0.610	0.012	0.024	

TSOT-23-8 Surface Mount Package

Richtek Technology Corporation

14F, No. 8, Tai Yuen 1st Street, Chupei City Hsinchu, Taiwan, R.O.C.

Tel: (8863)5526789

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